



MECHANICAL DATA

Dimensions in mm (inches)

0.30 (0.012) 8.89 (0.350) Rad. 1.14 - 0.15 (0.045 - 0.006) 1.27 (0.050) typ. 0.65 (0.025) ζ. 17 7.24 (0.285) 18 Rad. 1.14(0.045) 2.54 (0.100) 1.40 (0.055)

QUAD N-CHANNEL ENHANCEMENT MOSFETS

FEATURES

- HERMETIC CERAMIC SURFACE MOUNT PACKAGE
- LIGHTWEIGHT
- MILITARY SCREENING LEVEL OPTIONS
- SPACE QUALITY LEVELS OPTIONS

LCC18 Ceramic Package

Pin 1 - Drain 1	Pin 2 - N/C	Pin 3 - Gate 1
Pin 4 - Source 1	Pin 5 - Gate 2	Pin 6 - N/C
Pin 7 - Source 2	Pin 8 - N/C	Pin 9 - Drain 2
Pin 10 - Drain 3	Pin 11 - N/C	Pin 12 - Source 3
Pin 13 - Gate 3	Pin 14 - Source 4	Pin 15 - N/C
Pin 16 - Gate 4	Pin 17 - N/C	Pin 18 - Drain 4

APPLICATIONS

- FAST SWITCHING
- MOTOR CONTROLS
- POWER SUPPLIES

ABSOLUTE MAXIMUM RATINGS FOR EACH CHIP($T_{case} = 25^{\circ}C$ unless otherwise stated)

V_{DS}	Drain Source Voltage	100V		
I_{D}	Continuous Drain Current	1A		
$I_{D} @ T_{C} = 100^{\circ}C$	Continuous Drain Current	0.6A		
I _{DM}	Pulsed Drain Current *	4A		
V_{GS}	Gate Source Voltage	±20V		
P_{D}	Maximum Power Dissipation	3.5W		
$R_{\theta JC}$	Thermal Resistance Junction to Case	35.7°C/W		
$T_{J,T_{Stg}}$	Operating and Storage Temperature Range	-55 to +150°C		

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.

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MCA3703

ELECTRICAL CHARACTERISTICS FOR EACH CHIP(T_{case} = 25°C unless otherwise stated)

	Parameter	Test Conditions		Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain – Source Breakdown Voltage	$V_{GS} = 0$	$I_D = 1mA$	100			V	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu A$	2.0		4.0] '	
I _{GSSF}	Gate – Source Leakage Forward	V _{GS} = 20V				100	nA	
I _{GSSR}	Gate – Source Leakage Reverse	V _{GS} = -20V				-100] ''^	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80V.	V _{GS} =0			25	μΑ	
			T _C = 125°C			250		
Ь	Static Drain Source On-State	V _{GS} = 10V	I _D = 0.6A			0.70	Ω	
R _{DS(on)}	Resistance*	$V_{GS} = 10V$	I _D = 1.0A			0.80		
gfs	Forward Transductance *	$V_{DS} = 15V$	I _{DS} = 0.6A	0.86			S (U)	
C _{iss}	Input Capacitance	$V_{GS} = 0$	$V_{DS} = 25V$		180			
C _{oss}	Output Capacitance	f = 1MHz			82		pF	
C _{rss}	Reverse Transfer Capacitance				15		1	
Q _g	Total Gate Charge	V _{GS} = 10V	V _{DS} = 50V			15		
Q _{gs}	Gate – Source Charge	I _{DS} = 1.0A				7.5	1	
Q_{gd}	Gate – Drain Charge					7.5	nC nC	
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 50V$	I _D = 1.0A			20		
t _r	Rise Time	$R_G = 24\Omega$				25	1 ,	
t _{d(off)}	Turn-Off Delay Time	(MOSFET switchi	ng times are essentially			40	ns	
t _f	Fall Time	independent of operating temperature.)				40		
	BODY- DRAIN DIODE RATINGS & (CHARACTERIS	TICS					
Is	Continuous Source Current Body	Modified MOS POWER				4.0	_ A	
	Diode	symbol showing th			1.0			
I _{SM}	Source Current* (Body Diode)	P-N junction rectif			4.0			
V _{SD}	Diode Forward Voltage *	I _S = 1.0A	V _{GS} = 0			1.5	V	
t _{rr}	Reverse Recovery Time	I _F =1.0A	T _J = 25°C			200	ns	
Q _{RR}	Reverse Recovery Charge	$d_i / d_t = 100A/\mu$	us V _{DD} = 50V			0.83	μС	

Notes

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^{*} Pulse Test: Pulse Width $\leq 300 \mu s, \, \delta \leq 2\%$